







$25 \mu s \& 0.02\% F.S.$

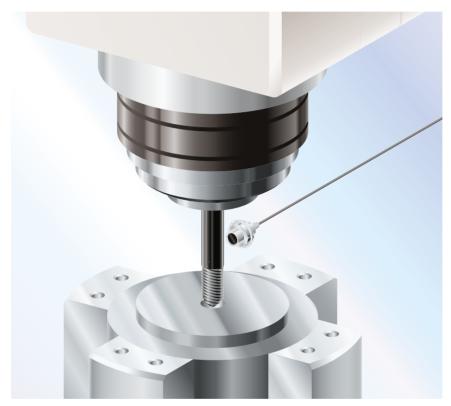
High-speed sampling and high resolution.

The new choice for even more variegated data collection and processing.



The unique sensing technology developed by our SUNX team has made possible an ultra-high speed minute displacement measurement function, essential for high-precision processes, that boasts the highest resolution in the industry.

High Speed High Resolution



We've realized a 25 μ s (40,000 times/sec.) ultra high sampling speed

With a 25 μ s ultra high sampling speed, the **GP-X** series won't miss even high speed work displacements.

These devices boast a 0.07 % F.S./°C temperature characteristics

By combining the sensor head with the controller, we've realized 0.07 % F.S./°C. They are highly resistant to ambient temperature changes enabling stable micro-displacement measurements.

They possess a 0.02 % F.S. resolution for highly accurate measurement

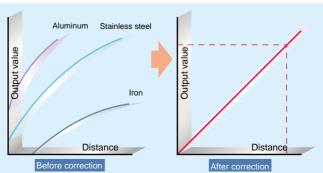
With the industry's highest resolution, 0.02 % F.S. (Note), they can perform high-accuracy measurements of micro-displacements. (Average number of samples: 64)

Note: GP-XC3SE and GP-XC5SE Resolution: 0.04 %F.S.

They perform with a ± 0.3 %F.S. linearity for stainless steel and iron

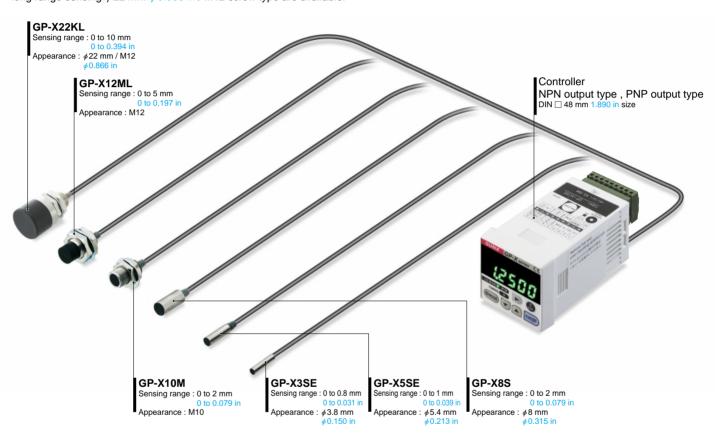
Because they perform with a ± 0.3 % F.S. linearity, they can be used for sensing stainless steel and iron enabling precise measurements not affected by the work's material. Specifications corresponding to each material (stainless steel, iron, aluminum) has already been inputted in the controller enabling the easy selection of the setting that is most suitable for the particular material used.

Optimal correction of the output feature

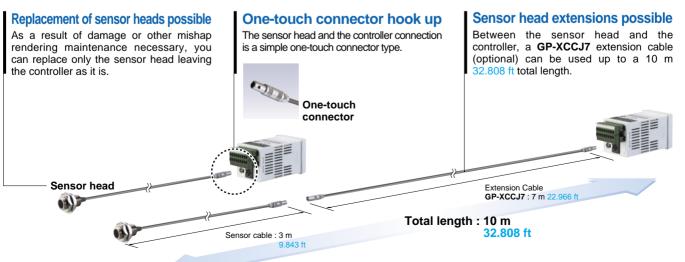


A total of 6 types of sensor head

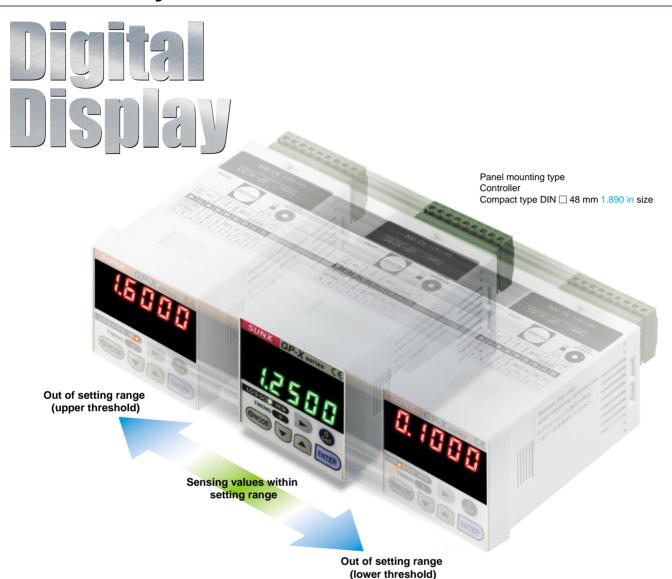
6 types of sensor heads from the ultra compact ϕ 3.8 mm ϕ 0.150 in cylindrical type to the long range sensing ϕ 22 mm ϕ 0.866 in / M12 screw type are available.



Sensor heads with superior workability and maintainability



The SUNX sensor design policy has realized controllers that are easy to use on-site.

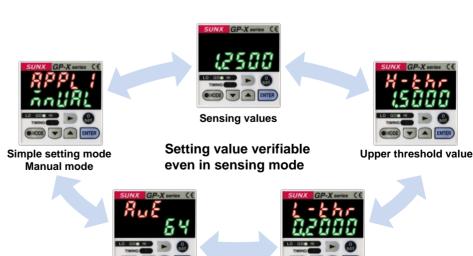


The 5-digit, dual, 2-color digital display offers great visibility

If the measurement results fall within the setting range (GO), they will appear on the lower digital display in green. If they are out of range (HI, LO), they will be displayed in the upper digital in orange. The display position and color change allows for accurate visibility even for momentary changes.

Digital input display enabling easy setting

Its dual digital display enables numerical setting while verifying setting items for each mode. Even when sensing, it enables the verification of the main settings.



Lower threshold value

Average number of

samples setting value

Instantaneous output of measurement data in BCD data format.

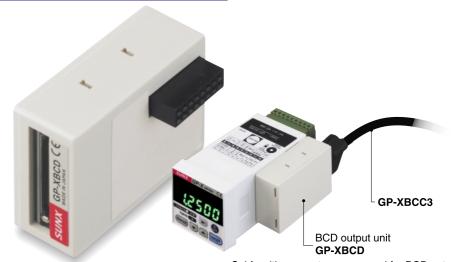
Digital Out

BCD output unit GP-XBCD (optional)

20 kHz high-speed data output

The measurement data can be processed quickly in the PLC.

(Sampling frequency: 20 kHz)



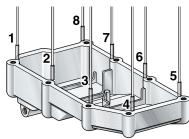
• Cable with connector on one end for BCD output unit **GP-XBCC3** (optional)

Cable length: 3 m 9.843 ft

Controller side : BCD connector
Output side : Multi-core cable

Mutual interference prevention function

The sensor head can be made interference prevention by linking up to 8 controllers via an interference prevention output cable and shifting the oscillation timing. This enables precise measurements to be obtained even in cases where many sensor heads are crowded in the same area.



4 types of selectable memory functions

The setting data can be processed in 4 types of memory when measuring. This function enables either the changing of the workpiece, the sensing of multiple products or sensing after product changeover to be done smoothly.

4 types of measurement modes available

Measurement modes compatible to the most widely used applications are available. Because of this, inputting setting values can be done with ease. Please select the most appropriate mode to suit your specific application.

<Manual set mode>



Removable type terminal block

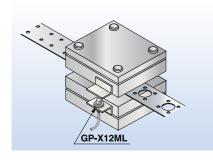
It is equipped with a removable type European terminal block very convenient during assembly, when dividing the equipment into segments or when performing maintenance. It also features an reverse insertion prevention construction.

European terminal block



<Stroke end sensing mode>





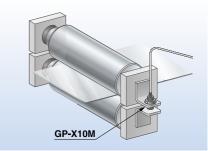
Rotation / eccentricity / vibration sensing mode



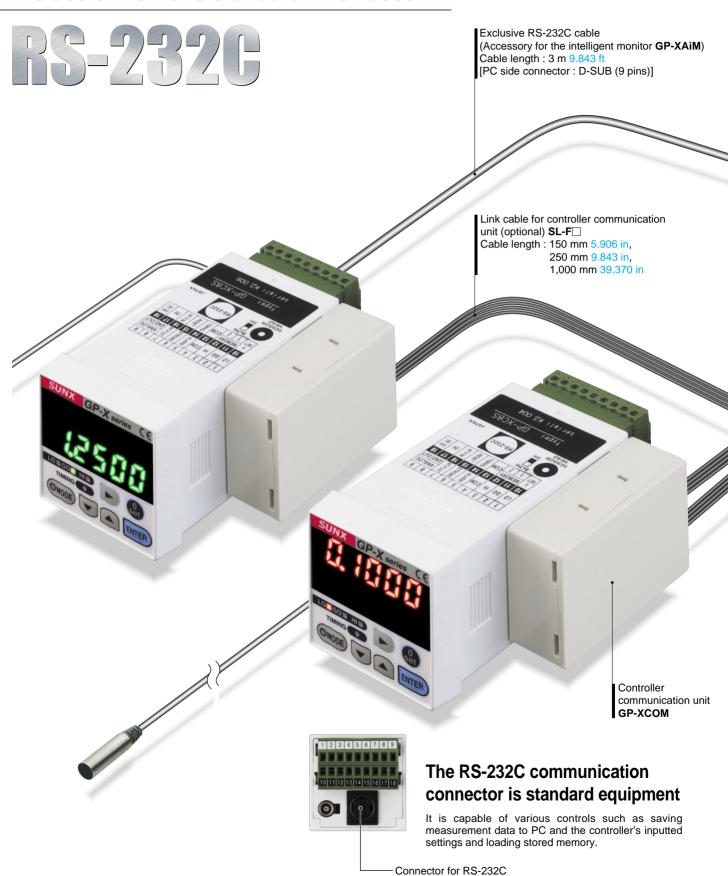


<Height sensing mode>





Various functions made available through the use of RS-232C standard interfaces.



communication





Intelligent monitor (GP-XAiM) optimal for collecting and analyzing measurement data.

(Exclusive RC-232C cable is attached)

An intelligent monitor capable of the settings for each measurement conditions and waveform display monitoring. It can perform waveform monitoring, which could until now only be done by the oscilloscope, as well as the simple loading and saving onto a PC of settings for each condition and function.

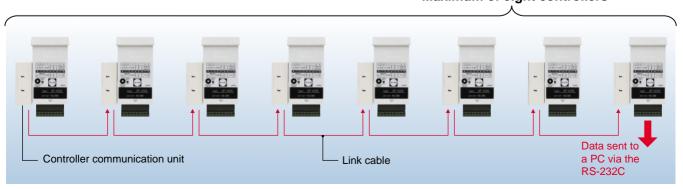
Enables sensors data comparisons and calculations

3-value judgment output for calculating measurement data conformity and calculation results between 2 interconnected controllers is rendered possible. The calculation function equipment renders digital panel controllers unnecessary.

Datalink between sensors possible

The controller communication unit **GP-XCOM** (optional) can be linked to up to 8 controllers and load via just one RS-232C cable each controller settings and measurement data to a PC.

Maximum of eight controllers



ORDER GUIDE

Time	Appearance (mm in)		Consing rooms	Set Model No.	Comporative output
Type	Sensor heads	Controller	Sensing range	(Sensor head model No.)	Comparative output
70	\$3.8 \$\$\display\$0.150		0 to 0.8 mm	GP-XC3SE (GP-X3SE) (Note)	NPN open-collector transistor
Non-threaded type sensor head	17 0.669		☐ 0 to 0.031 in	GP-XC3SE-P (GP-X3SE) (Note)	PNP open-collector transistor
pe sen	¢5.4 ¢0.213		0 to 1 mm	GP-XC5SE (GP-X5SE) (Note)	NPN open-collector transistor
aded ty	17 0.669		0 to 0.039 in	GP-XC5SE-P (GP-X5SE) (Note)	PNP open-collector transistor
lon-thre		83	0 to 2 mm	GP-XC8S (GP-X8S)	NPN open-collector transistor
Z	φ8 φ0.315 17 0.669	48	0 to 0.079 in	GP-XC8S-P (GP-X8S)	PNP open-collector transistor
	1.890	0 to 2 mm	GP-XC10M (GP-X10M)	NPN open-collector transistor	
r head	M10 17 0.669	1.890	0 to 0.079 in	GP-XC10M-P (GP-X10M)	PNP open-collector transistor
senso			0 to 5 mm	GP-XC12ML (GP-X12ML)	NPN open-collector transistor
Threaded type sensor head	M12 21 0.827		0 to 0.197 in	GP-XC12ML-P (GP-X12ML)	PNP open-collector transistor
	M12		0 to 10 mm	GP-XC22KL (GP-X22KL)	NPN open-collector transistor
	¢22 0.866 1.378		0 to 0.394 in	GP-XC22KL-P (GP-X22KL)	PNP open-collector transistor

Note: High resolution types (GP-XC3S, GP-XC5S: 0.02 % F.S., average number of samples: 64) are available. These products correspond to the Export Trade Administration Act of Japan. Shipping them outside Japan requires special permission from the Japanese government regarding stipulations in Foreign Exchange and Foreign Trade Law. Please contact our office for details.

OPTIONS

Designation	Model No.	Description		
BCD output unit	GP-XBCD	This unit outputs measurement values in BCD data format at a high • Sampling frequency : 20 kHz		
Cable with connector on one end for BCD output unit	for GP-XBCC3 Length: 3 m 9.843 ft		Cable for BCD data output unit. • 26-core cable with connector on one end	
Controller communication unit GP-XCOI		Up to 8 controllers can be linked.		
Link cable for	SL-F150	Length: 150 mm 5.906 in		
controller	SL-F250	Length: 250 mm 9.843 in	This cable links the controller communication units. Select as per the cable length.	
communication unit	SL-F1000	Length: 1,000 mm 39.370 in		
Intelligent monitor	GP-XAiM	Monitoring settings for each measurement condition and measure waveforms is enabled by way of a PC. • One exclusive RS-232C cable (3 m 9.843 ft length) is attached.		
Extension cable for sensor head	GP-XCCJ7	Length: 7 m 22.966 ft	This cable with connector is for extensions between the sensor head and controller.	

BCD output unit Cable with connector on one end for BCD output unit BCD output unit GP-XBCD Link cable for controlle communication unit Cable with connector on one end

for BCD output unit GP-XBCC3

SL-F□

Controller communication unit Intelligent monitor Link cable for controller communication unit

> Controller communication unit

GP-XCOM

· GP-XAiM



Extension cable for sensor head • GP-XCCJ7





SPECIFICATIONS

Sensor heads

Туре			Non-threaded type)	Threaded type		
		For 0.8 mm 0.031 in sensing	For 1 mm 0.039 in sensing	For 2 mm 0.079 in sensing	For 2 mm 0.079 in sensing	For 5 mm 0.197 in sensing	For 10 mm 0.394 in sensing
Item	Model No.	GP-X3SE	GP-X5SE	GP-X8S	GP-X10M	GP-X12ML	GP-X22KL
Sen	sing range (Note 1)	0 to 0.8 mm 0 to 0.031 in	0 to 1 mm 0 to 0.039 in	0 to 2 mm 0 to 0.079 in	0 to 2 mm 0 to 0.079 in	0 to 5 mm 0 to 0.197 in	0 to 10 mm 0 to 0.394 in
Stan	dard sensing object	Stainless steel	(SUS304) / Iron shee	t [Cold rolled carbon s	steel (SPCC)] 60 × 60	×t 1 mm 2.362×2.	362×t 0.039 in
Temp	perature characteristics (Note 2)			0.07 % F.S	./°C or less		
	Pollution degree			3 (Industrial	environment)		
900	Protection	IP67 (IEC), IP67g (JEM)					
Environmental resistance	Ambient temperature	-10 to +55 °C +14 to +131 °F, Storage: -20 to +70 °C -4 to +158 °F					
a E	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH					
nent	Voltage withstandability	250 V AC for one min. between all supply terminals connected together and enclosure					
iron	Insulation resistance	20 MΩ, or more, with 250 V DC megger between all supply terminals connected together and enclosure					
Env	Vibration resistance	10 to	150 Hz frequency, 0.	.75 mm 0.030 in ampl	itude in X, Y and Z dir	ections for two hours	each
	Shock resistance		500 m/s ² accelera	tion (50 G approx.) in	X, Y and Z directions	for five times each	
70	Enclosure		Stainless steel (SUS303) Brass (Nickel plated)				
Material	Cable protector		PP				
Š	Sensing Part	ABS	PAR	PAR ABS		F	PA
Cable		High frequency coaxial cable with connector, 3 m 9.843 ft long (Note 3)					
Cable extension			Extension up	to total 10 m 32.808	ft is possible with the	optional cable	
Weig	ght (Note 4)	40 g approx.	40 g approx.	40 g approx.	50 g approx.	45 g approx.	80 g approx.
Acce	essories			·	Nut: 2 pc	cs., Toothed lock was	ner: 1 pc.

- Notes: 1) The sensing range is specified for the standard sensing object.

 2) This value represents 20 to 60 % of the maximum sensing distance when combining the sensor head and the controller.

 3) For the flexible cable type, please contact our office.

 4) The given weight of the threaded type sensor head is the value including the weight of the nuts and the toothed lock washer.

SPECIFICATIONS

Controllers

		Туре	NPN output	PNP output			
Iten	n 🔪	Set model No.	GP-XC□	GP-XC□-P			
Sup	ply voltag	je	24 V DC ± 10 % Rij	pple P-P 10 % or less			
Curr	rent cons	umption	150 mA or less				
Res	olution (N	lote 1)	GP-XC3SE / GP-XC5SE: 0.04 %F.S. (64 times GP-XC8S / GP-XC10M / GP-XC12ML / GP-XC	average processing) 22KL: 0.02 %F.S. (64 times average processing)			
Sam	npling free	quency	40 kHz	(25 μs)			
Line	arity (Not	te 1)	Within ±	0.3 %F.S.			
Temp	perature ch	naracteristics (Note 2)	0.07 %F.S	./°C or less			
Ana	log voltag	ge output	Output voltage: -5 to +5 V (Note:	3), Output impedance: 100 Ω approx.			
		Response time	75 μs (maxi	mum speed)			
Comparative outputs (HI, GO, LO)			NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less (between comparative output and 0 V) • Residual voltage: 1.6 V or less (at 100 mA sink current) 0.4 V or less (at 16 mA sink current)	PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between comparative output and +V) • Residual voltage: 1.6 V or less (at 100 mA source current) 0.4 V or less (at 16 mA source current)			
		Utilization category	DC-12 c	or DC-13			
		Output number	HI/GO/LO	3 value output			
	Output operation		HI : ON when measured value > the upper limit value GO: ON when upper limit value ≥ measured value ≥ lower limit value LO: ON when lower limit value > measured value				
		Short-circuit protection	Incorporated				
External input		t	Photocoupler input • Input current: 9 mA or less • Operating voltage: ON voltage 17 V or more (between $+24$ V and input) OFF voltage 4 V or less (between $+24$ V and input) • Input impedance: 5 k Ω approx.	Photocoupler input Input current: 9 mA or less Operating voltage: ON voltage 17 V or more (between 0 V and input) OFF voltage 4 V or less (between 0 V and input) Input impedance: 5 kΩ approx.			
Seri	al I/O		RS-2	232C			
Zero	o-set setti	ng method	Push button setting / External input setting				
	MODE		Orange LED (lights up	when in mode status)			
Indicators	HI		Orange LED (lights up when the upper limit value is exceeded)				
lica	GO		Green LED (lights up when withir	n the upper and lower limit values)			
≧	LO		Orange LED (lights up when l	less than the lower limit value)			
	TIMING		Green LED (lights up as per the	external or internal trigger timing)			
Upp	er line di	gital display part	5 digit orange LED (display of numerical v	values out of upper and lower limit values)			
	er line di	gital display part	5 digit green LED (display of numerical val	ues within the upper and lower limit values)			
ance	Pollution		3 (Industrial environment)				
Environmental resistance		temperature	0 to $+$ 50 °C $+$ 32 to $+$ 122 °F (No dew condensation), Storage: 0 to $+$ 50 °C $+$ 32 to $+$ 122 °F				
ıtal re		humidity	35 to 85 % RH, Storage: 35 to 85 % RH				
mer	EMC		EN 61000-6-2, EN 61000-6-4				
wiror	Vibration resistance			tude in X, Y and Z directions for two hours each			
			` ' ' '	X, Y and Z directions for five times each			
Mate				Polycarbonate			
Wei				approx.			
	essory			mounting frame): 1 set			
Notes: 1) This value is obtained a			at a constant +25 °C +77 °F				

- Notes: 1) This value is obtained at a constant $+25\,^{\circ}\text{C}$ $+77\,^{\circ}\text{F}$.

 2) This value represents 20 to 60 % of the maximum sensing distance when combining the sensor head and the controller.
 - 3) Adjusted to a 0 to +5 V factory setting.

BCD output unit

Model No.	GP-XBCD
Current consumption	20 mA or less
Output 5 digits BCD, Polarity indication, VALID	N-channel MOSFET open drain Maximum sink current: 50 mA Applied voltage: 30 V DC or less (between output and GND) Residual voltage: 1 V or less (at 50 mA sink current)
Hold input	Non-voltage contact or NPN open-collector transistor input • Low: 0 to 1 V • High: Open
Material	Enclosure: ABS
Weight	30 g арргох.
Accessory	Mounting bracket [Stainless steel (SUS304)]: 1 pc.

Note: Connects to the control device with **GP-XBCC3** cable with connector on one end for BCD output unit (3 m 9.843 ft cable length, optional).

Controller communication unit

Model No.	GP-XCOM	
Current consumption	5 mA or less	
Material	Enclosure: ABS	
Weight	20 g approx.	
Accessory	Mounting bracket [Stainless steel (SUS304)]: 1 pc.	

Note: Each **GP-XCOM** is connected using a link cable for controller communication units (**SL-F**□, optional).

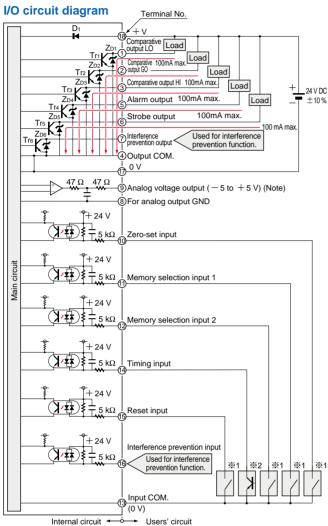
When GP-XCOM is used, controllers cannot communicate if their software versions are not compatible (Ver. 1.06 or earlier version with Ver 2.00 or later version).

Check the software version and use the correct combination.



I/O CIRCUIT AND WIRING DIAGRAMS

NPN output type controller



Note: Devices connected to the analog voltage output must have an input impedance set at 1 $\mbox{M}\Omega$ or more.

Symbols ... D1: Reverse supply polarity protection diode ZD1 to ZD6: Surge absorption zener diode Tr1 to Tr6: NPN output transistor

<u>**1</u>

Non-voltage contact or NPN open-collector transistor
or

Zero-set input, reset input, memory selection input

Low (0 to 4 V) : Effective High (+V or open) : Ineffective

%2

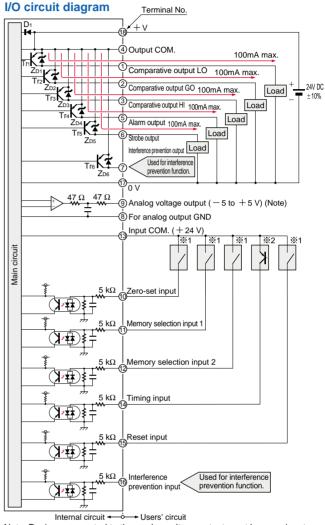
NPN open-collector transistor

Timing input
Low (0 to 4 V): Effective
High (+ V or open): Ineffective

Memory selection input

- 1							
	Memory No.	Memory selection 1	Memory selection 2				
	0	High	High				
	1	Low	High				
	2	High	Low				
Ī	3	Low	Low				

PNP output type controller



Note: Devices connected to the analog voltage output must have an input impedance set at 1 $\mbox{M}\Omega$ or more.

Symbols ... D1: Reverse supply polarity protection diode ZD1 to ZD6: Surge absorption zener diode Tr1 to Tr6: PNP output transistor

※1

Non-voltage contact or PNP open-collector transistor

 Zero-set input, reset input, memory selection input Low (0 V or open) : Ineffective High (+ 17 V to + 24 V) : Effective

%2

PNP open-collector transistor

Timing input
Low (0 V or open): Ineffective
High (+ 17 to + 24 V): Effective

Memory selection input

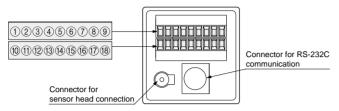
momory coloculor input						
Memory No.	Memory selection 1	Memory selection 2				
0	Low	Low				
1	High	Low				
2	Low	High				
3	High	High				



I/O CIRCUIT AND WIRING DIAGRAMS

Controller

Terminal arrangement



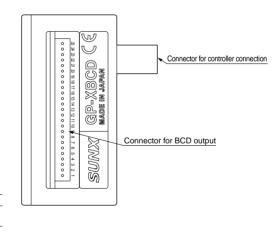
Terminal No.	Description	
1	Comparative output LO	
2	Comparative output GO	
3	Comparative output HI	
4	Output COM.	
(5)	Alarm output	
6	Strobe output	
7	Interference prevention output	
8	For analog output GND	
9	Analog output	

Terminal No.	Description		
10	Zero-set input		
(1)	Memory selection input 1		
(12)	Memory selection input 2		
13	Input COM.		
14)	Timing input		
15)	Reset input		
16	Interference prevention input		
17)	0 V		
18	+ V		

BCD output unit

Connector pin position and cable color

Connector	Ca	ble	Signal	Descript		ion
pin No.	Sheath color	ID mark	Signal			1011
1	Orange	Red: 1	A0	1×		
2	Orange	Black: 1	B0	2×	Measurement value	
3	Gray	Red: 1	C0	4×	to the 100 digit	
4	Gray	Black: 1	D0	8×		
(5)	White	Red: 1	A1	1X		
6	White	Black: 1	B1	2×	Measurement value	
7	Yellow	Red: 1	C1	4×	to the 101 digit	
8	Yellow	Black: 1	D1	8×		
9	Pink	Red: 1	A2	1X		
10	Pink	Black: 1	B2	2×	Measurement value	Measurement value
(1)	Orange	Red: 2	C2	4×	to the 10 ² digit	BCD output
(12)	Orange	Black: 2	D2	8×		
13	Gray	Red: 2	A3	1X		
(14)	Gray	Black: 2	В3	2×	Measurement value	
(15)	White	Red: 2	C3	4×	to the 103 digit	
16	White	Black: 2	D3	8×		
17	Yellow	Red: 2	A4	1X		
(18)	Yellow	Black: 2	B4	2×	Measurement value	
(19)	Pink	Red: 2	C4	4×	to the 10 ⁴ digit	
20	Pink	Black: 2	D4	8×		
21)	Orange	Red: 3	POLE	Polarit	y signal output	High (OFF): +, Low (ON): -
2	Orange	Black: 3	VALID	VALID output		Low (ON) when the data output is enabled
23	Gray	Red: 3	HOLD	Hold input		This input is to maintain the external data output. The data output is maintained during low (ON).
24	Gray	Black: 3	GND	Ground		
25	White	Red: 3	GND	Ground		
	White	Black: 3	_	Not co	nnected	Not used



Note: The shield wire is connected externally at 0 V.

PRECAUTIONS FOR PROPER USE



This product is not a safety sensor. Its use is not intended or designed to protect life and prevent body injury or property damage from dangerous parts of machinery. It is a normal object detection sensor.

- The sensor head and the controller are adjusted in order to conform to the default specification linearity.
- In the event of replacing sensor heads, input the sensor head's characteristic code and conduct 3-point correction (calibration).
- Should you use an extension cable, turn the sensor head cable length selection switch located on the back of the controller to '3 m + 7 m 9.843 ft + 22.966 ft'. Then reintroduce the power supply and conduct 3-point correction (calibration).

Conditions in use for CE conformity

 This sensor is a CE conformity product complying with EMC Directive. The harmonized standard with regard to immunity that applies to this product is EN 61000-6-2 and the following conditions must be met to conform to that standard.

Conditions

- The controller should be connected <u>less than 10 m 32.808 ft</u> from the power supply.
- The signal line to connect with the controller should be <u>less than</u> 30 m 98.425 ft.
- A ferrite clamp must be mounted within 10 mm 0.394 in from connector fitted onto the GP-XBCC3 cable with connector on one end for BCD output units.

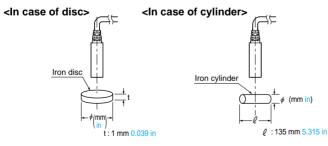
The EN 50082-2 that previously applied to the products for conforming to EMC Directive was replaced by EN 61000-6-2 starting April 1st. 2002.

Linearity in case of disc-shaped or cylindrical objects

• In case the sensing object is disc-shaped or cylindrical, the linearity varies with the sensing object size.

In the event the sensing object is larger than the sizes indicated in the table below, the linearity specification (within $\pm\,0.3$ % F.S.) is satisfied by performing zero-adjustment and span adjustment when in contact using the scaling function.

Sensor head	Disc diameter ϕ (mm in)	Cylinder diameter ϕ (mm in)			
GP-X3SE	6 0.236	16 0.630			
GP-X5SE	8 0.315	16 0.630			
GP-X8S	12 0.472	50 1.969			
GP-X10M	12 0.472	50 1.969			
GP-X12ML	25 0.984	55 2.165			
GP-X22KL	30 1.181	165 6.496			

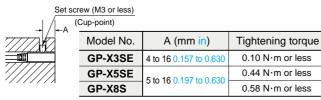


Mounting sensor head

• The tightening torque should be under the value given below.

Mounting with set screw

• Make sure to use an M3 or smaller set screw having a cup-point.



Mounting with nut

<GP-X10M> <GP-X12ML>







Model No.	B (mm in)	Tightening torque
GP-X10M	7 0.276 or more	9.8 N⋅m or less
GP-X12ML	14 0.551 or more	20 N⋅m or less
GP-X22KL	20 0.787 or more (Note 1)	20 N⋅m or less

Notes: 1) Without nut. If a nut is installed, the dimension will be 23.5 mm or more.

2) Mount such that the nuts do not protrude from the threaded portion.

Distance from surrounding metal

 As metal around the sensor may affect the sensing performance, pay attention to the following points.

<Embedding of the sensor head in metal>

 Since the analog output may change if the sensor head is completely embedded in metal, keep the minimum distance specified in the table below.



Sensor head	C (mm in)	D (mm in)
GP-X3SE	410 40 204	3 0.118
GP-X5SE	<i>φ</i> 10 <i>φ</i> 0.394	
GP-X8S	<i>ϕ</i> 18 <i>ϕ</i> 0.709	3 0.110
GP-X10M	φ14 φ0.551	
GP-X12ML	φ50 φ1.969	14 0.551
GP-X22KL	φ50 φ 1.969	20 0.787

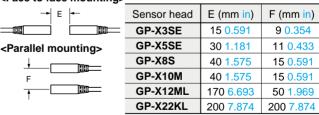
Mutual interference

• If several sensor heads are mounted close together, some specifications may not be satisfied. Therefore, proceed with the interference prevention function enabled.

The interference prevention function eliminates interference among sensors by alternating sensor oscillations. Contact our office for details about time charts etc.

If not using the interference prevention function, leave a distance more than the values given below.

<Face to face mounting>



Sensing range

• The sensing range is specified for the standard sensing object [stainless steel (SUS304) / iron [Cold rolled carbon steel (SPCC)], $60\times60\times t$ 1 mm $2.362\times 2.362\times t$ 0.039 in]. For sensing metals other than the standard sensing objects, use the correction coefficient stated below as a guideline. Verify with the actual sensor before using.

Correction coefficient

Sensor head Metal	GP-X3SE GP-X10M GP-X5SE GP-X12ML GP-X8S GP-X22KL	
Stainless steel (SUS304), Iron	1	
Aluminum	0.5 approx.	

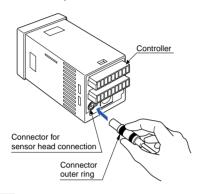
PRECAUTIONS FOR PROPER USE

Connection of sensor head and controller

 Make sure that the power supply is off while connecting the sensor head to the controller.

Connection

 Hold the sensor head's connector by the outer ring and insert it into the connector provided on the controller for sensor head connection. Insert till you hear a click sound.

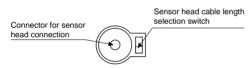


Removing

 When removing, hold the connector outer ring and pull it straight out.

Cable extension for sensor head

 When using a sensor head extension cable, turn the sensor head cable length selection switch side to the controller's sensor head connector to '3 m + 7 m 9.843 ft + 22.966 ft' with the power supply is off. After switching, reintroduce the power supply.

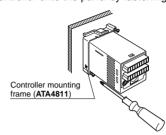


UP side : Standard (3 m 9.843 ft) $\,+\,$ extension (7 m 22.966 ft) DOWN side : Standard (3 m 9.843 ft) (factory shipment setting)

 The coaxial connector for the extension cable is connected to the 0 V power supply. If installing to a metal plate or similar, insulate the connector from the surrounding metal.

Mounting controller

• Use the attached controller mounting frame (ATA4811) and mount the controller onto the panel by fastening the frame's screws.



- Refer to the 'DIMENSIONS' (P.14) for the panel cut-out dimension.
- The mountable panel thickness is 1 to 5 mm 0.039 to 0.197 in. However, if using a controller communication unit or BCD output unit, make the panel thickness between 1 and 2.5 mm 0.039 and 0.098 in.

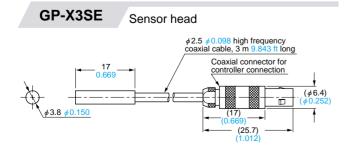
Wiring

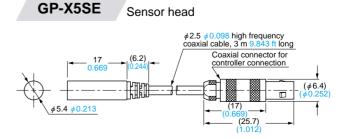
- Make sure that the power supply is off while wiring.
- Take care that wrong wiring will damage the sensor head or the controller.
- Verify that the supply voltage variation is within the rating.
- If power is supplied from a commercial switching regulator, ensure that the frame ground (F.G.) terminal of the power supply is connected to an actual ground.
- In case noise generating equipment (switching regulator, inverter motor, etc.) is used in the vicinity of the sensor head or the controller, connect the frame ground (F.G.) terminal of the equipment to an actual ground.
- Do not run the wires together with high-voltage lines or power lines or put them in the same raceway. This can cause malfunction due to induction.
- Make sure to use an isolation transformer for the power supply. It an auto-transformer (single winding transformer) is used, this product or the power supply may get damaged.
- In case a surge is generated in the used power supply, connect a surge absorber to the supply and absorb the surge.
- The analog voltage output does not incorporate a short-circuit protection circuit. Do not directly connect a power supply or a capacitive load.
- Make sure that stress by forcible bend or pulling is not applied directly to the sensor cable joint.
- If using separate power supplies for multiple controllers, use the same + V or 0 V supply for all.

Others

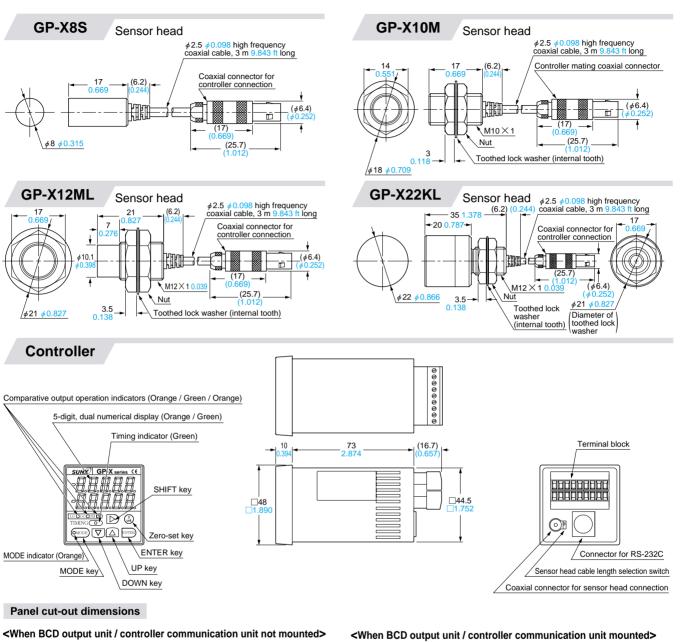
- Do not use during the initial transient time (2 sec. approx.) after the power supply is switched on.
- This sensor is suitable for indoor use only.
- Avoid dust, dirt, and steam
- Take care that the product does not come in direct contact with water, oil, grease, or organic solvents, such as, thinner, etc.

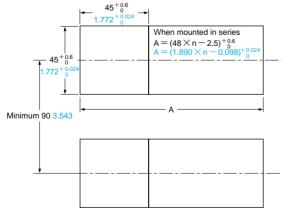
DIMENSIONS (Unit: mm in) The CAD data in the dimensions can be downloaded from the SUNX website: http://www.sunx.co.jp/



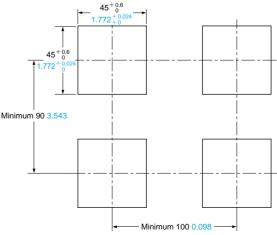


DIMENSIONS (Unit: mm in) The CAD data in the dimensions can be downloaded from the SUNX website: http://www.sunx.co.jp/





Note: The panel thickness should be 1 to 5 mm 0.039 to 0.197 in.

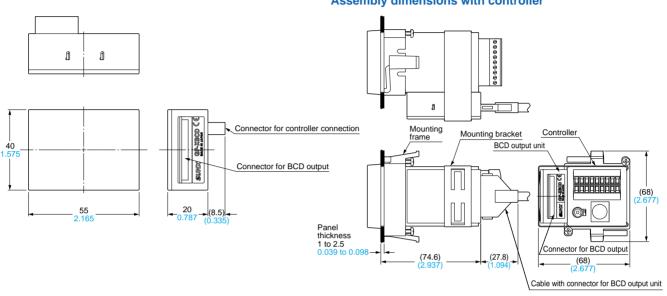


Note: The panel thickness should be 1 to 2.5 mm 0.039 to 0.098 in.



GP-XBCD BCD output unit (Optional)

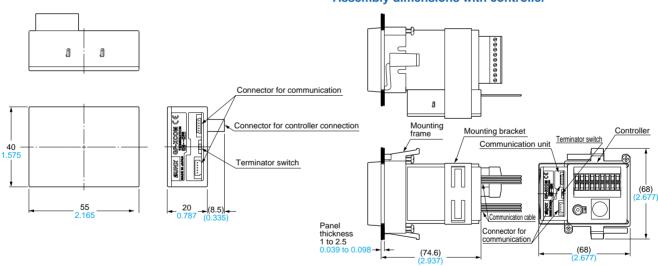
Assembly dimensions with controller



GP-XCOM

Controller communication unit (optional)

Assembly dimensions with controller



All information is subject to change without prior notice.



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